



Product Change Notification

Change Notification #: 117039 - 00
Change Title: Select Intel® Data Center Blocks for Cloud, MCB2224BPHY1, MCB2208WFHY2, MCB2224BPFAF3, MCB2208WFAF4, MCB2208WFAF5, MCB2208WFAF6, PCN 117039-00, Product Discontinuance, End Of Life
Date of Publication: July 01, 2019

Key Characteristics of the Change:

Product Discontinuance

Forecasted Key Milestones:

Product Discontinuance Program Support Begins:	July 01, 2019
Orders are Non-Cancelable and Non-Returnable After:	July 30, 2019
Last Product Discontinuance Order Date:	August 30, 2019
Last Product Discontinuance Shipment Date:	September 30, 2019

Description of Change to the Customer:

Intel is announcing the discontinuance of the Intel® Data Center Blocks for Cloud as listed in the "Products Affected/Intel Ordering Codes" table below.

Intel will make best efforts to support all orders placed between the NCNR and the LPDO dates. After the LPDO date existing inventory is still orderable, under NCNR terms, and will be filled on a first come first served basis. Deliveries must be accepted within 90 days from the LPDO date.

Final purchase orders are non-cancelable and non-returnable, notwithstanding any conflicting terms in our quotes, purchase order acknowledgement or Distributor agreements.

Engineering and Support Guidance for Discontinued Products:

1. No new OS validation is planned. The THOL, supported processor and tested memory lists are frozen at PDA date.
2. No new features enhancements should be expected, however ECOs may be required to maintain supply lines (e.g. to qualify new vendor due to a component EOL).
3. Intel will provide reasonable commercial efforts in debugging issues during the warranty period for the product after the PDA date has passed. Fixes cannot be committed, but Intel will endeavor to provide reasonable workarounds for the product.

Intel reserves the right to change the products because of material source restriction.

Customer Impact of Change and Recommended Action:

Determine your remaining demand for this product and/or evaluate additional sources (if applicable). Volumes are not buffered subsequent to PDA. Please work with your Intel representative on your quarterly demand forecast in order to reduce lead-times to 2 - 4 Weeks.

Please contact your local Intel Sales Office or Distributor if you require more information or need assistance in selecting a replacement product. Milestone dates are estimates and subject to change based on business and operational conditions.

Products Affected / Intel Ordering Codes:

Product Name	Product Code	MM#	Recommended Replacement Product Code	Recommended Replacement MM#
Intel® Server System MCB2208WFAF6	MCB2208WFAF6	999DMA	MCB2208WFAF9R	999GKR
Intel® Server System MCB2224BPAF3	MCB2224BPAF3	9999P4	MCB2224BPAF3R	999LDM
Intel® Server System MCB2208WFAF5	MCB2208WFAF5	999DMC	MCB2208WFAF7R	999GKV
Intel® Server System MCB2208WFAF4	MCB2208WFAF4	999DMD	MCB2208WFAF4R	999GKZ
Intel® Server System MCB2208WFHY2	MCB2208WFHY2	999DMF	MCB2312WFHY2R	999JKT
Intel® Server System MCB2224BPHY1	MCB2224BPHY1	9999PD	MCB2224BPHY1R	999LDP

PCN Revision History:

Date of Revision:
July 01, 2019

Revision Number:
00

Reason:
Originally Published PCN



Product Change Notification

117039 - 00

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The products described in this document may contain design defects or errors known as errata which may cause the product to deviate from published specifications. Current characterized errata are available on request.

Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.

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